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				APPLICANT: B. HEINEM	ANN et al.				
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			UNITED STA	TES PATENT DOCUMENT	·s				
EXAM. INITIAL		DOCUMENT NUMBER	DATE	INVENTOR/ASSIGNEE	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE		
		2005/0023642	Feb. 03, 2005	Heinemann et al.					
		2003/0146477	Aug. 07, 2003	Krutsick					
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		EP 0 746 038	Dec. 19, 2001	EP					
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	2	D. Knoll et al., "A flexible, low-cost, high performance SiGe:C BiCMOS process with a one-mask HBT module," IEEE, 2002.							
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Sheet 2 of 2 IAP20 Rec'd PCT/PTO 30 MAY 2006

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